AUTOMOTIVE

COMPLIANT

HALOGEN FREE

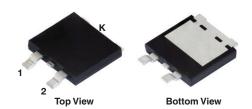


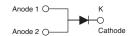
# Vishay General Semiconductor

# Low-Voltage TMBS® (Trench MOS Barrier Schottky) Rectifier

Ultra Low  $V_F = 0.31 \text{ V}$  at  $I_F = 5 \text{ A}$ 

## eSMP® Series SMPD (TO-263AC)





## **ADDITIONAL RESOURCES**



PRIMARY CHARACTERISTICS				
I <sub>F(AV)</sub>	20 A			
V <sub>RRM</sub>	45 V			
I <sub>FSM</sub>	160 A			
V <sub>F</sub> at I <sub>F</sub> = 20 A (T <sub>A</sub> = 125 °C)	0.50 V			
T <sub>J</sub> max.	150 °C			
Package	SMPD (TO-263AC)			
Circuit configuration	Single			

#### **FEATURES**

- Trench MOS Schottky technology
- Very low profile typical height of 1.7 mm
- Ideal for automated placement
- · Low forward voltage drop, low power losses
- · High efficiency operation
- Meets MSL level 1, per J-STD-020, LF maximum peak of 260 °C
- AEC-Q101 qualified available
  - Automotive ordering code; base P/NHM3
- Material categorization: for definitions of compliance please see <a href="https://www.vishay.com/doc?99912">www.vishay.com/doc?99912</a>

#### TYPICAL APPLICATIONS

For use in high frequency DC/DC converters, switching power supplies, freewheeling diodes, OR-ing diode, and reverse battery protection.

#### **MECHANICAL DATA**

Case: SMPD (TO-263AC)

Molding compound meets UL 94 V-0 flammability rating Base P/N-M3 - halogen-free, RoHS-compliant, and commercial grade

Base P/NHM3\_X - halogen-free, RoHS-compliant, and AEC-Q101 qualified

("\_X" denotes revision code e.g. A, B,....)

**Terminals:** matte tin plated leads, solderable per J-STD-002 and JESD 22-B102

M3 suffix meets JESD 201 class 2 whisker test, HM3 suffix meets JESD 201 class 2 whisker test

Polarity: as marked

MAXIMUM RATINGS (T <sub>A</sub> = 25 °C unless otherwise noted)				
PARAMETER	SYMBOL	V20DL45	UNIT	
Maximum repetitive peak reverse voltage	$V_{RRM}$	45	V	
Maximum average forward rectified current (fig. 1)	I <sub>F(AV)</sub> (1)	20	Α	
Peak forward surge current 10 ms single half sine-wave superimposed on rated load	I <sub>FSM</sub>	160	А	
Operating junction and storage temperature range	T <sub>J</sub> , T <sub>STG</sub>	-40 to +150	°C	

#### Note

(1) With heatsink



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<b>ELECTRICAL CHARACTERISTICS</b> (T <sub>A</sub> = 25 °C unless otherwise noted)						
PARAMETER	TEST CO	TEST CONDITIONS		TYP.	MAX.	UNIT
Instantaneous forward voltage	I <sub>F</sub> = 5 A	T <sub>A</sub> = 25 °C	V <sub>F</sub> <sup>(1)</sup>	0.42	-	. V
	I <sub>F</sub> = 10 A			0.48	-	
	I <sub>F</sub> = 20 A			0.55	0.64	
	I <sub>F</sub> = 5 A	T <sub>A</sub> = 125 °C		0.31	-	
	I <sub>F</sub> = 10 A			0.38	-	
	I <sub>F</sub> = 20 A			0.50	0.58	
Reverse current	V <sub>R</sub> = 45 V	T <sub>A</sub> = 25 °C	I <sub>R</sub> <sup>(2)</sup>	-	2.5	- mA
	V <sub>R</sub> = 45 V	T <sub>A</sub> = 125 °C		20	50	

#### **Notes**

(1) Pulse test: 300 µs pulse width, 1 % duty cycle

(2) Pulse test: pulse width ≤ 5 ms

THERMAL CHARACTERISTICS (T <sub>A</sub> = 25 °C unless otherwise noted)				
PARAMETER SYMBOL V20DL45				
Typical thermal resistance	$R_{\theta JC}$	1.6	°C/W	
	R <sub>θJA</sub> (1)(2)	45		

#### **Notes**

 $^{(1)}$  The heat generated must be less than the thermal conductivity from junction-to-ambient:  $dP_D/dT_J < 1/R_{\theta JA}$ 

(2) Free air, without heatsink

ORDERING INFORMATION (Example)				
PREFERRED P/N	UNIT WEIGHT (g)	PREFERRED PACKAGE CODE	BASE QUANTITY	DELIVERY MODE
V20DL45-M3/I	0.54	I	2000/reel	13" diameter plastic tape and reel
V20DL45HM3_A/I (1)	0.54	I	2000/reel	13" diameter plastic tape and reel

#### Note

(1) AEC-Q101 qualified

### **RATINGS AND CHARACTERISTICS CURVES** (T<sub>A</sub> = 25 °C unless otherwise noted)

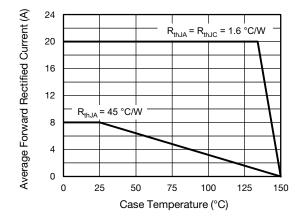


Fig. 1 - Forward Current Derating Curve

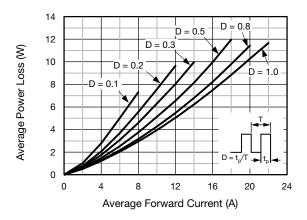


Fig. 2 - Forward Power Loss Characteristics



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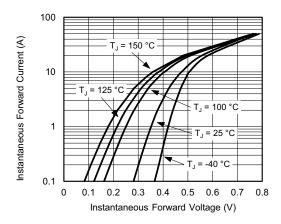


Fig. 3 - Typical Instantaneous Forward Characteristics

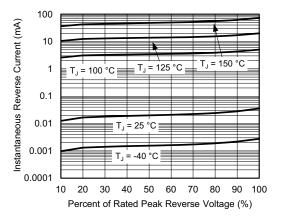


Fig. 4 - Typical Reverse Characteristics

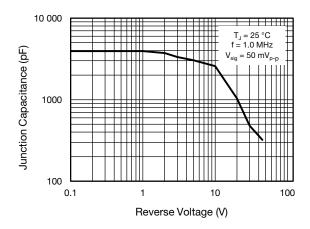


Fig. 5 - Typical Junction Capacitance

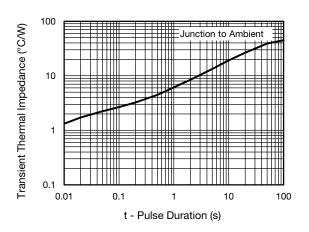


Fig. 6 - Typical Transient Thermal Impedance

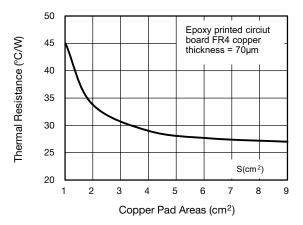


Fig. 7 - Thermal Resistance Junction-to-Ambient vs. Copper Pad Areas

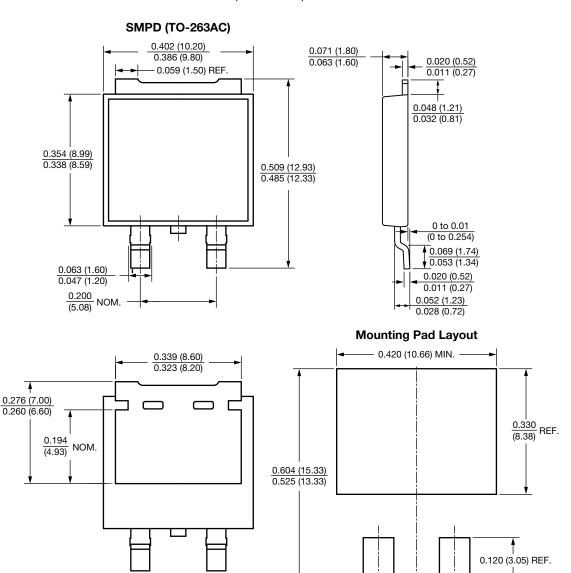


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0.105 (2.67)

0.095 (2.41)

### **PACKAGE OUTLINE DIMENSIONS** in inches (millimeters)



0.080 (2.03) MIN.



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